



NSF-Sponsored Summer Undergraduate Research Experience (SURE): Solid-State Devices for Electronics, Photonics, and Magnetics Technology



For More Information and to Apply: <http://www.clemson.edu/ces/ece/undergrad/SURE/>

The Holcombe Department of Electrical & Computer Engineering at Clemson University is seeking applicants for a summer Research Experiences for Undergraduates (REU) program. This NSF-funded program supports up to 10 summer students, with one to four semesters remaining in their undergraduate programs, to become involved with a faculty member and graduate students for a 10 week research experience at Clemson. There are approximately 10 projects and about 10 faculty from several departments involved in this program. The program provides student summer housing on campus and pays a generous stipend.

Key Dates and Deadlines:

March 31, 2015: Application Deadline
May 18, 2015: Program Begins
July 24, 2015: Program Ends

Eligibility Requirements

- Undergraduate students at accredited U.S. institutions.
- Majors: Electrical and Computer Engineering
Materials Science and Engineering
Bioengineering
Physics
- One to four academic semesters remaining until graduation at the time of participation
- U.S. citizenship or permanent-resident status
- Minimum grade point average of 3.4 out of 4.0

Competitive Compensation for Sure Participants.

The stipend is \$6,000 for the 10-week program.

Free on-campus housing is provided.

There is a relocation allowance for students not already enrolled at Clemson.

On-campus meal plans are available at a reasonable cost.